

N-Ch 30V Fast Switching MOSFETs

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

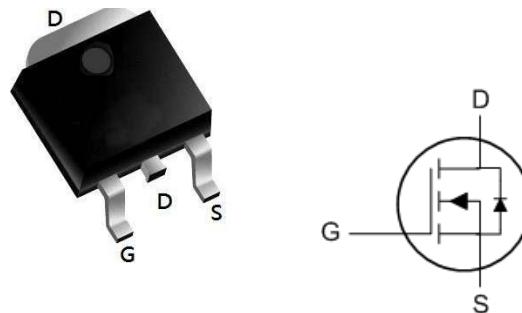


BVDSS	RDS(ON)	ID
30V	1.5mΩ	150A

Description

The XR150N03 is the high cell density trenched N-ch MOSFETs, which provide excellent RDS(ON) and gate charge for most of the synchronous buck converter applications. The XR150N03 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO252-3L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1,6}$	150	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1,6}$	80	A
I_{DM}	Pulsed Drain Current ²	450	A
EAS	Single Pulse Avalanche Energy ³	580	mJ
I_{AS}	Avalanche Current	60	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation ⁴	87	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	2.1	°C/W

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Electrical characteristic ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Off characteristics						
BV_{DSS}	Drain to source breakdown voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30			V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_{\text{D}}=250\mu\text{A}$, referenced to 25°C		0.02		$\text{V}/^\circ\text{C}$
I_{DSS}	Drain to source leakage current	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$			1	μA
		$V_{\text{DS}}=24\text{V}, T_J=125^\circ\text{C}$			50	μA
I_{GSS}	Gate to source leakage current, forward	$V_{\text{GS}}=20\text{V}, V_{\text{DS}}=0\text{V}$			100	nA
	Gate to source leakage current, reverse	$V_{\text{GS}}=-20\text{V}, V_{\text{DS}}=0\text{V}$			-100	nA
On characteristics						
$V_{\text{GS(TH)}}$	Gate threshold voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.2		2.4	V
$R_{\text{DS(ON)}}$	Drain to source on state resistance	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=30\text{A}, T_J=25^\circ\text{C}$		2.2	4.8	$\text{m}\Omega$
		$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}, T_J=25^\circ\text{C}$		1.5	2.9	$\text{m}\Omega$
		$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}, T_J=125^\circ\text{C}$		2.5		$\text{m}\Omega$
G_{fs}	Forward transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=30\text{A}$		73		S
Dynamic characteristics						
C_{iss}	Input capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V}, f=1\text{MHz}$		6272		pF
C_{oss}	Output capacitance			1022		
C_{rss}	Reverse transfer capacitance			718		
$t_{\text{d(on)}}$	Turn on delay time	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=30\text{A}, R_G=4.7\Omega, V_{\text{GS}}=10\text{V}$ (note 4,5)		20		ns
t_r	Rising time			58		
$t_{\text{d(off)}}$	Turn off delay time			158		
t_f	Fall time			77		
Q_g	Total gate charge	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}, I_G=5\text{mA}$ (note 4,5)		143		nC
Q_{gs}	Gate-source charge			17		
Q_{gd}	Gate-drain charge			43		
R_g	Gate resistance	$V_{\text{DS}}=0\text{V}, \text{Scan F mode}$		4.2		Ω

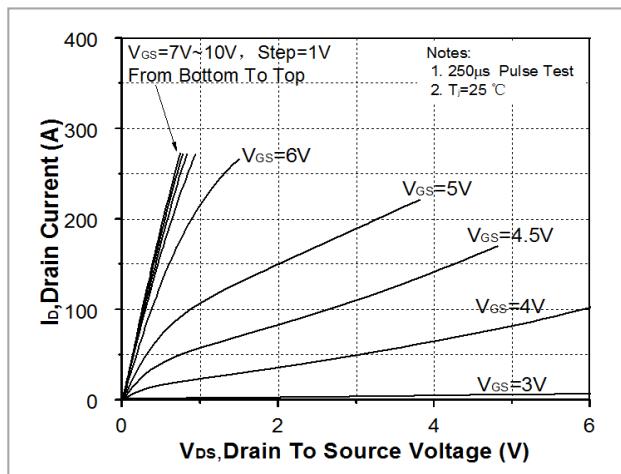
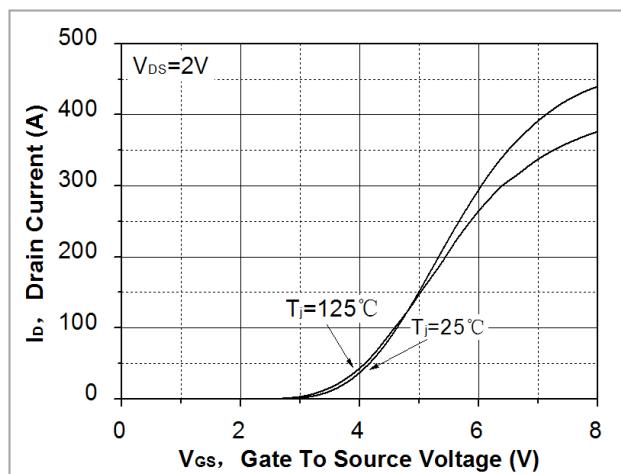
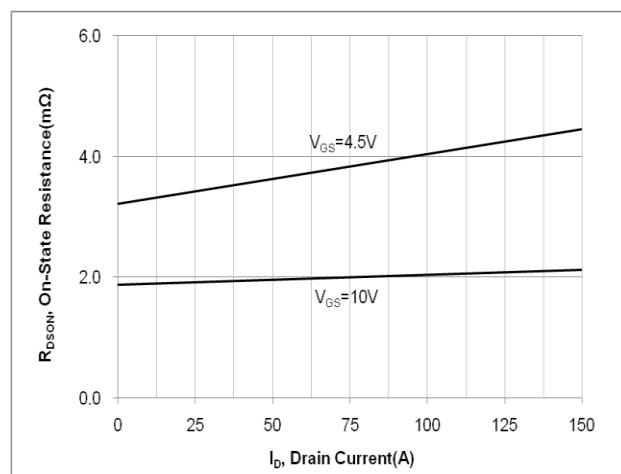
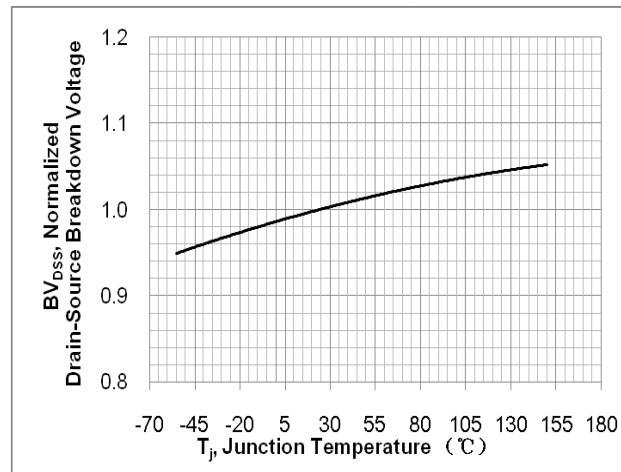
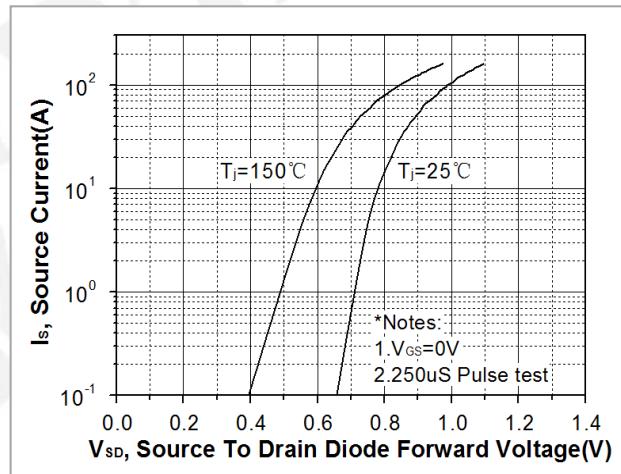
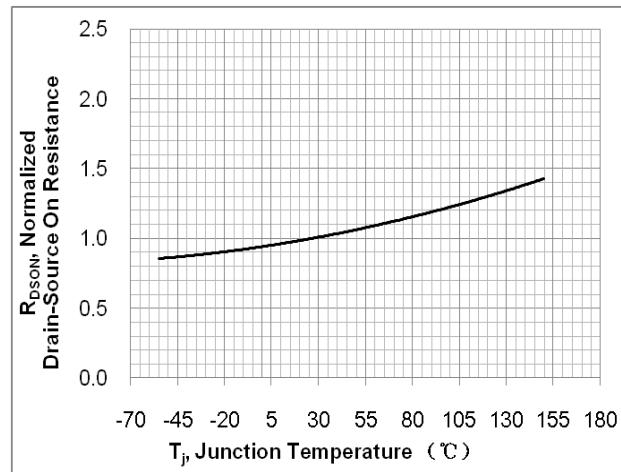
Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_s	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			110	A
I_{SM}	Pulsed source current				440	A
V_{SD}	Diode forward voltage drop.	$I_s=45\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
t_{rr}	Reverse recovery time	$I_s=30\text{A}, V_{\text{GS}}=0\text{V}, dI_F/dt=100\text{A/us}$		26		ns
Q_{rr}	Reverse recovery charge			10		nC

※. Notes

- Repetitive rating : pulse width limited by junction temperature.
- $L=0.5\text{mH}, I_{\text{AS}}=48\text{A}, V_{\text{DD}}=30\text{V}, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
- $I_{\text{SD}} \leq 30\text{A}, dI/dt = 100\text{A/us}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, Starting $T_J=25^\circ\text{C}$
- Pulse Test : Pulse Width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
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Fig. 1. On-state characteristics**Fig. 2. Transfer Characteristics****Fig. 3. On-resistance variation vs. drain current and gate voltage****Fig 5. Breakdown voltage variation vs. junction temperature****Fig. 4. On-state current vs. diode forward voltage****Fig. 6. On-resistance variation vs. junction temperature**

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Fig. 7. Gate charge characteristics

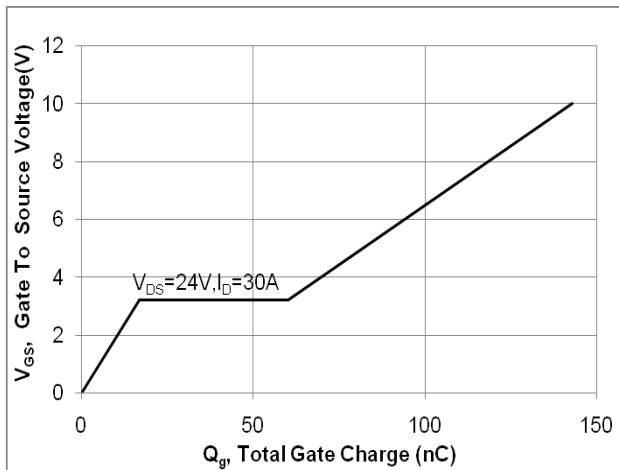


Fig. 8. Capacitance Characteristics

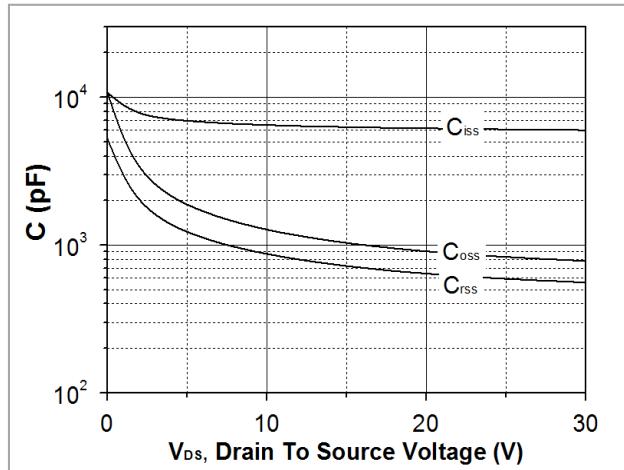


Fig. 9. Maximum safe operating area

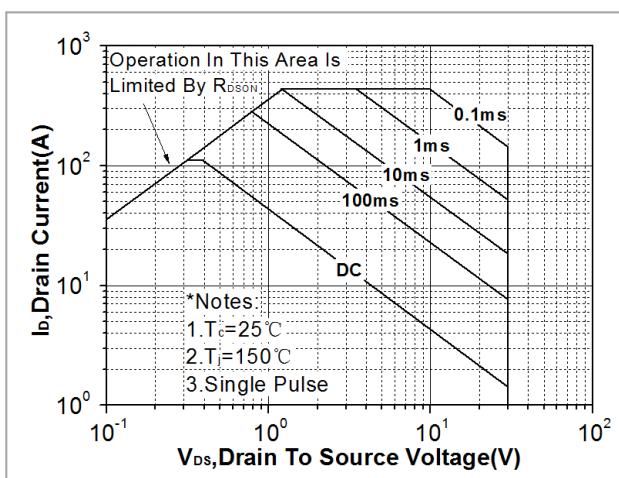


Fig. 10. Maximum drain current vs. case temperature

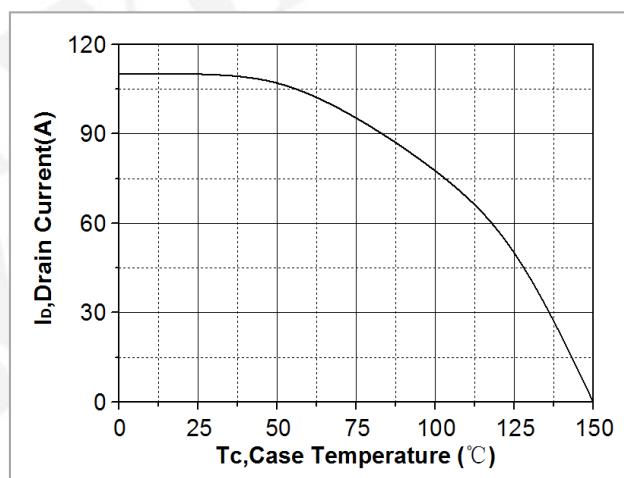
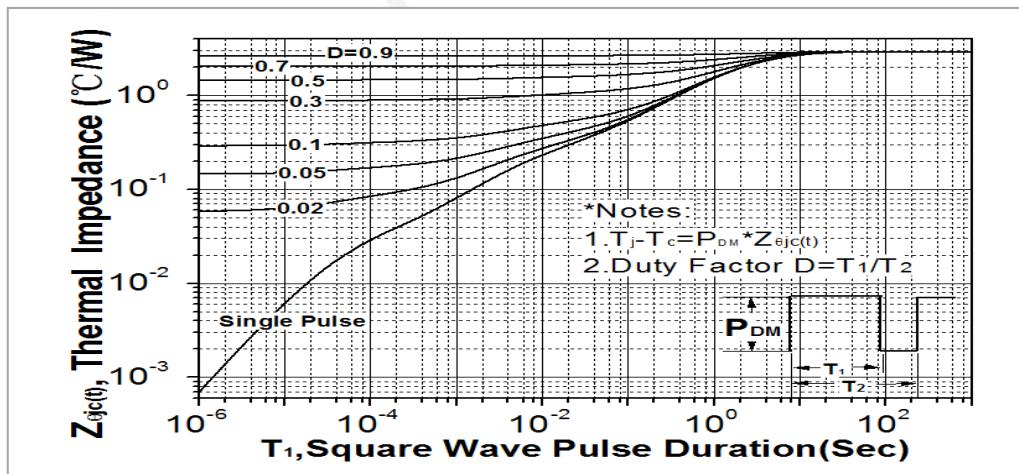


Fig. 11. Transient thermal response curve



Test Circuit

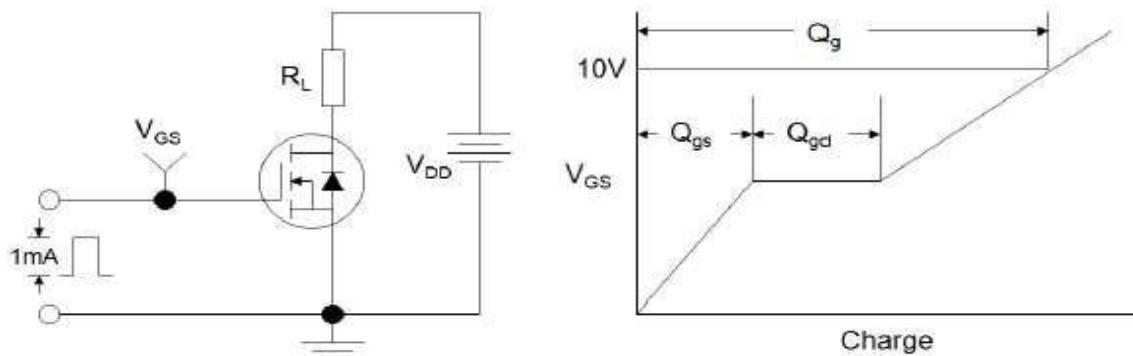


Figure 1: Gate Charge Test Circuit & Waveform

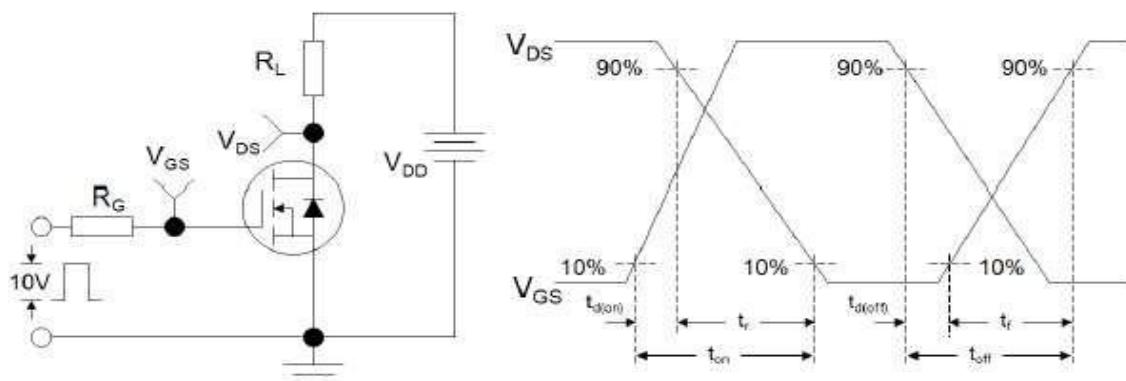


Figure 2: Resistive Switching Test Circuit & Waveforms

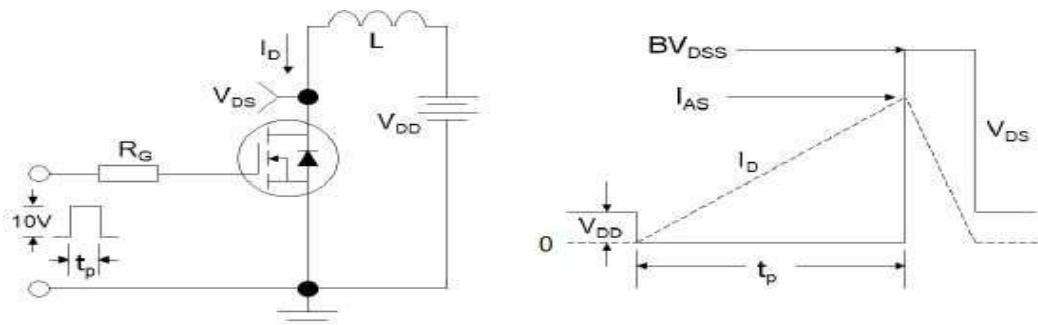
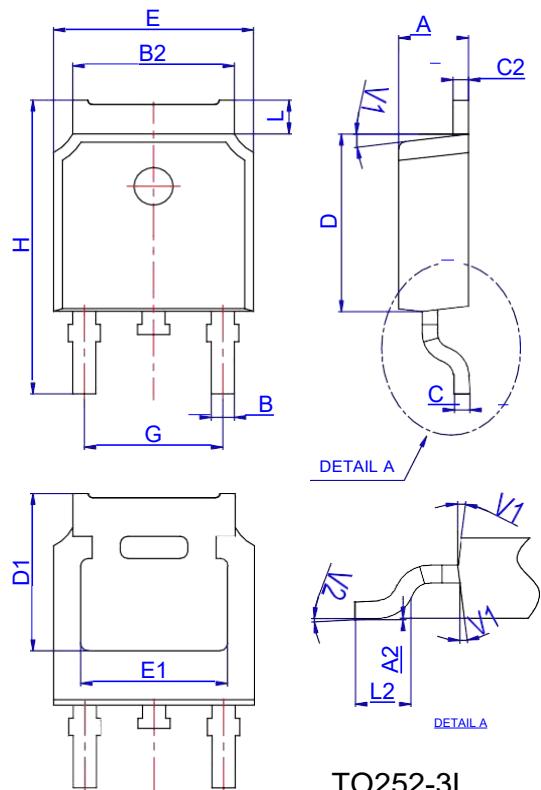


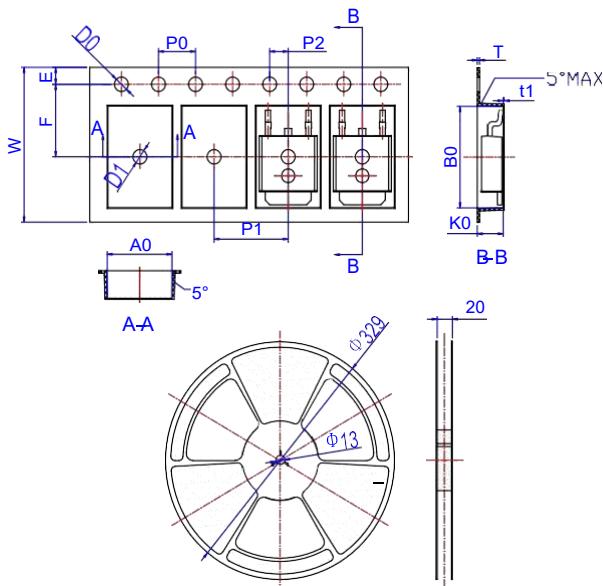
Figure 3: Unclamped Inductive Switching Test Circuit & Waveforms

Package Mechanical Data TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583